

# AF Control LSI

LC898249XH

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#### Overview

This LSI is Closed-Auto Focus control LSI equipped with hall sensor. It consists of 1 system of feedback circuit and constant current driver. It has also a built-in EEPROM and temperature sensor.

#### **Features**

- Built-in Equalizer Circuit Using Digital Operation
  - AF Control Equalizer Circuit
  - Any Coefficient can be Specified by 2-wire Serial I/F (TWIF)
- 2-wire Serial Interface

(The Communication Protocol is Compatible with I<sup>2</sup>C)

- 4 Selectable Slave Addresses
  - -50h(W)/51h(R), 53h(R)
  - -74h(W)/75h(R), 77h(R)
  - -E8h(W)/E9h(R), EBh(R)
  - E4h(W)/E5h(R), E7h(R) factory-configured

Right Side Addresses are Used at the Access of Built-in EEPROM

- Built-in A/D Converter
- Built-in D/A Converter
  - ◆ Hall Offset
  - Constant Current Bias
- Built-in Hall Sensor
  - Si Hall Sensor
- Built-in EEPROM
  - 64 Byte (16 Byte / Page)
- Built-in OSC
- Built-in Constant Current Driver
  - ◆ 150 mA
- Package
  - ◆ WLCSP 6-pin (2 x 3 Pin), Thickness Max 0.29 mm, with Backside Coat
- Supply Voltage
  - VDD (2.6 V to 3.3 V)
- This Device is Pb–Free, Halogen Free/BFR Free and is RoHS Compliant



WLCSP6, 0.86x1.75x0.265 CASE 567XD

#### **MARKING DIAGRAM**

8249XH ALYWW

8249XH = Specific Device Code A = Assembly Location

L = Wafer Lot
 Y = Year
 WW = Work Week

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
LC898249XHTBG	WLCSP6	4000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### **PIN DESCRIPTION**

**Table 1. PIN DESCRIPTION** 

Pin Name	Description
I	Input
Р	Power Supply, GND
NC	Not Connect
0	Output
В	Bidirection

• 2-wire serial interface

SCL I 2-wire serial interface clock pin SDA B 2-wire serial interface data pin

• Driver interface

OUT1 O Driver output (to Actuator)
OUT2 O Driver output (to Actuator)

• Power supply pin

VDD P Power Supply

VSS P GND

\*Process when pins are not used

PIN TYPE "O" – Ensure that it is set to OPEN.

PIN TYPE "I" – OPEN is inhibited. Ensure that it is connected to the VDD or VSS even when it is unused.

(Please contact **onsemi** for more information about selection of VDD or VSS.)

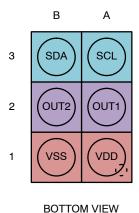
PIN TYPE "B" – If you are unsure about processing method on the pin description of pin layout table, please contact us.

Note that incorrect processing of unused pins may result in defects.

#### **PIN LAYOUT**

**Table 2. PIN LAYOUT** 

Circuit Name	Number of PINs
Driver	2
Power	2
Logic	2



A B

3 (SCL) (SDA)

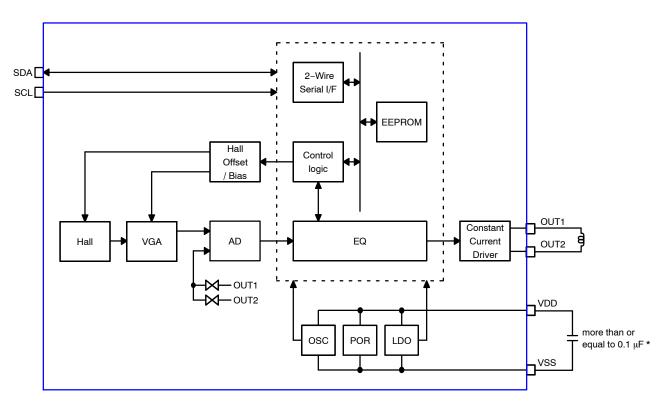
2 (OUT1) (OUT2)

1 (VDD) (VSS)

TOP VIEW

Figure 1. Pin Layout

## **BLOCK DIAGRAM**



<sup>\*</sup>Consider capacitance of capacitor between VDD and VSS. According to power source environment, attach an additional capacitor in camera module.

Figure 2. Block Diagram

## **HALL ELEMENT POSITION**

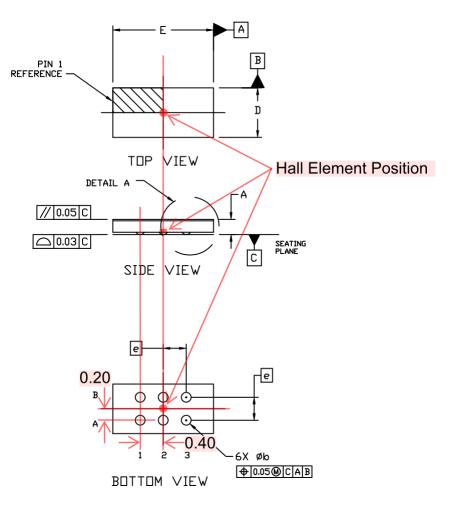


Figure 3. Hall Element Position

#### **ELECTRICAL CHARACTERISTICS**

## **Table 3. ABSOLUTE MAXIMUM RATINGS (VSS = 0 V)**

Symbol	Item	Condition	Rating	Unit
V <sub>DD</sub> 33 max	Supply voltage	Ta ≤ 25°C	-0.3~4.6	V
V <sub>I</sub> 33,V <sub>O</sub> 33	Input/output voltage	Ta ≤ 25°C	-0.3~V <sub>DD</sub> 33 + 0.3	V
Tstg	Storage ambient temperature		-55~125	°C
Topr	Operating ambient temperature		-30~70	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## Table 4. ACCEPTABLE OPERATION RANGE (Ta = -30~70°C, VSS = 0 V, 3 V power supply (VDD))

Symbol	ltem	Min	Тур	Max	Unit
V <sub>DD</sub> 33	Supply voltage	2.6	2.8	3.3	V
V <sub>IN</sub>	Input voltage range	0	-	$V_{DD}33$	V

#### Table 5. DC CHARACTERISTICS (Input / output level at VSS = 0 V, VDD = 2.6 V~3.3V, Ta = -30~70°C)

Symbol	Item	Condition	Min	Тур	Max	Unit	Applicable Pins
VIH	High-level input voltage	CMOS compliant schmitt	1.4	-	_	V	SCL, SDA
VIL	Low-level input voltage		-	-	0.4	V	
VOL	Low-level output voltage	IOL = 2 mA	-	-	0.2	V	SDA

#### Table 6. DRIVER OUTPUT (OUT1, OUT2) (VSS = 0 V, VDD = 2.8 V, Ta = 25°C)

Symbol	ltem	Condition	Min	Тур	Max	Unit	Applicable Pins
Ifull	Maximum current		142.5	150	157.5	mA	OUT1, OUT2

#### Table 7. NON-VOLATILE MEMORY CHARACTERISTICS

Symbol	ltem	Condition	Min	Тур	Max	Unit	Applicable Circuit
EN	Endurance		-	-	1000	Cycles	EEPROM
RT	Data retention		10	-	-	Years	
tWT	Write time		-	_	20	ms	

## **AC CHARACTERISTICS**

# **VDD Supply Timing**

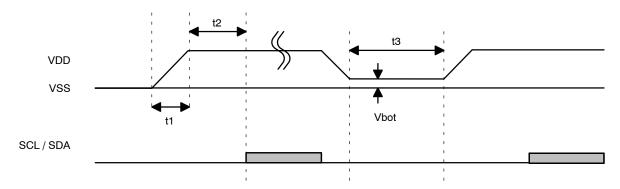


Figure 4. VDD Supply Timing

It is available to use 2-wire serial interface 5 ms later for Power On Reset of VDD.

**Table 8. VDD SUPPLY TIMING** 

Symbol	Item		Тур	Max	Unit
t1	VDD turn on time	-	ı	3	ms
t2	2-wire serial interface start time from VDD on	5	-	-	ms
t3	VDD off time	100	-	-	ms
Vbot	Bottom Voltage	-	1	0.1	V

# **AC Specification**

Figure 5 shows interface timing definition and Table 9 shows electric characteristics.

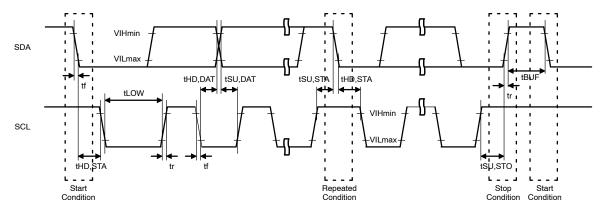


Figure 5. 2-wire Serial Interface Timing Definition

Table 9. ELECTRICAL CHARACTERISTICS FOR 2-WIRE SERIAL INTERFACE (AC CHARACTERISTICS)

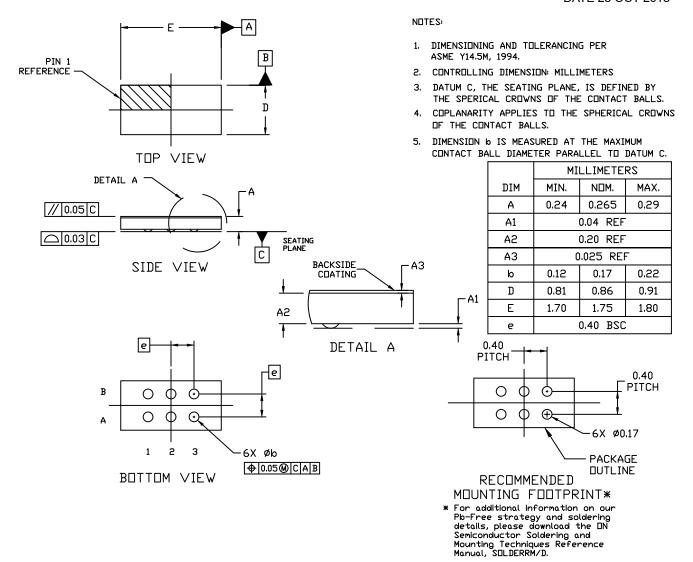
			F	ast-mode	)	Fast-mode Plus		lus	
Symbol	ltem	Pin Name	Min	Тур	Max	Min	Тур	Max	Unit
FSCL	SCL clock frequency	SCL	-	-	400	-	-	1000	kHz
tHD,STA	START condition hold time	SCL SDA	0.6	-	-	0.26	-	-	μs
tLOW	SCL clock Low period	SCL	1.3	-	-	0.5	-	-	μs
tHIGH	SCL clock High period	SCL	0.6	-	-	0.26	-	-	μs
tSU,STA	Setup time for repetition START condition	SCL SDA	0.6	-	-	0.26	-	-	μS
tHD,DAT	Data hold time	SCL SDA	0 (Note 1)	-	0.9	0 (Note 1)	-	-	μS
tSU,DAT	Data setup time	SCL SDA	100	-	-	50	-	-	ns
tr	SDA, SCL rising time	SCL SDA	-	-	300	-	-	120	ns
tf	SDA, SCL falling time	SCL SDA	-	-	300	-	-	120	ns
tSU,STO	STOP condition setup time	SCL SDA	0.6	-	-	0.26	-	-	μS
tBUF	Bus free time between STOP and START	SCL SDA	1.3	-	-	0.5	-	-	μs

<sup>1.</sup> This LSI is designed for a condition with typ. 20 ns of hold time. If SDA signal is unstable around falling point of SCL signal, please implement an appropriate treatment on board, such as inserting a resistor.

# WLCSP6, 0.86x1.75x0.265

CASE 567XD ISSUE O

**DATE 23 OCT 2018** 



GENERIC MARKING DIAGRAM\*

°XXXXXX ALYWW XXXX = Specific Device Code

A = Assembly Location L = Wafer Lot

Y = Year WW = Work Week \*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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